# mos integrated circuit $\mu$ PD4712C/4712D

# **RS-232 LINE DRIVER/RECEIVER**

The  $\mu$ PD4712C and 4712D are high-voltage silicon gate CMOS line driver/reciever conforming to the EIA/TIA-232-E standard. It can operate with a single +5 V power source because it is provided with a DC-DC converter. In addition, this line driver/receiver has many ancillary functions, including output control, threshold select, and standby functions. Because the  $\mu$ PD4712C and 4712D are provided with four output driver circuits and four receiver circuits, it can constitute an RS-232 interface circuit with a single chip.

### FEATURES

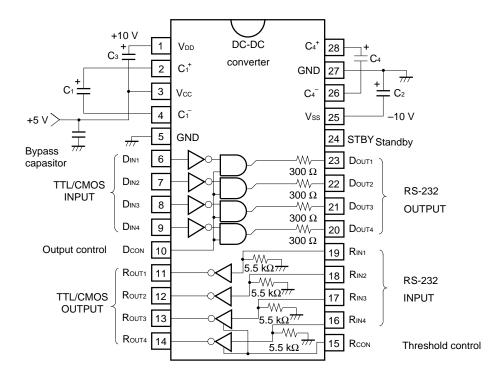
NEC

- Conforms to EIA/TIA-232-E (RS-232C) standard
- +5 V single power source
- · Threshold select pin selecting two types of threshold voltages
- Standby mode can be set by making standby pin high to reduce circuit current.
- Three-state output configuration. Both driver and receiver outputs go into high-impedance state in standby mode.

### ORDERING INFORMATION

Part Number	Package
μPD4712CCY	28-pin plastic DIP (400 mil)
μPD4712DCY	28-pin plastic DIP (400 mil)
μPD4712CGT	28-pin plastic SOP (375 mil)
μPD4712DGT	28-pin plastic SOP (375 mil)

# BLOCK DIAGRAM/PIN CONFIGURATION (Top View)



- \* VDD and Vss are output pins of voltages internally boosted. Connecting a load directly to these pins is not recommended.
- \*\* The standby pin is internally pulled down.
- \*\*\* Use capacitors with a working voltage of 16 V or higher as C<sub>1</sub> through C<sub>4</sub>. Insert a bypass capasitor about 0.1 to 1  $\mu$ F between Vcc pin to GND pin.

# TRUTH TABLE

# Drivers

STBY	DCON	DIN	Dout	Remark
н	Х	Х	Z	Standby mode (DC-DC converter stops)
L	L	Х	L	Mark level output
L	н	L	н	Space level output
L	н	н	L	Mark level output

#### Receivers

STBY	Rin	Rout	Remark
н	Х	Z	Stanby mode (DC-DC converter stops)
L	L	н	Mark level input
L	н	L	Space level input

# Receiver input threshold voltage

RCON	RIN1 to RIN2	RIN3 to RIN4
L	A mode	A mode
Н	A mode	B mode*/C mode **

\*: μPD4712C, \*\*: μPD4712D

H: high level, L: low level, Z: high impedance, X: H or L

# ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Parameter	Symbol	Ratings	Unit
Supply voltage	Vcc	-0.5 to +6.0	V
Driver input voltage	DIN	-0.5 to Vcc +0.5	V
Receiver input voltage	Rin	-30.0 to +30.0	V
Driver output voltage	Dout	-25.0 to +25.0 Note1	V
Receiver output voltage	Rout	-0.5 to Vcc + 0.5	V
Receiver input current	lin	±60.0	mA
Operating temperature range	TA	-40 to +85	°C
Storage temperature range	Tstg	-55 to +150	°C
Power dissipation	Ρτ	0.5	W

Note 1. Pulse width: 1 ms, duty factor: 10 % MAX.

### **RECOMMENDED OPERATING RANGE**

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply voltage	Vcc	4.5	5.0	5.5	V
Receiver input voltage	RIN	-30		+30	V
Operating temperature range	TA	-20		80	°C
External capacitance	Note 2	4.7		47	μF

**Note 2.** The capacitance of an electrolytic capacitor decreases at a low temperature (0 °C or lower). Determine the capacitance of the capacitor to be used taking this into consideration when the  $\mu$ PD4712C and 4712D are used at a low temperature. Keep the wiring length between the capacitor and IC as short as possible.

# ELECTRICAL CHARACTERISTICS (OVERALL) (Unless otherwise specified, V<sub>cc</sub> = +5 V $\pm$ 10 %, T<sub>A</sub> = -20 °C to +80 °C, C<sub>1</sub> to C<sub>4</sub> = 22 $\mu$ F)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Circuit current		Vcc = +5 V, no load, R <sub>IN</sub> pin open				
	Icc1	(Standby pin open)		9.0	18.0	mA
Circuit current		$V_{CC} = +5 \text{ V},  \text{R}_{\text{L}} = 3  \text{k} \Omega \text{ (Dout)},  \text{Din} = \text{GND},$				
	Icc2	RIN and ROUT pins open		25.0	40.0	mA
		(Standby pin open)				
Standby circuit current	Icc	Vcc = +5 V, no load, R <sub>IN</sub> pin open		- 0	100	
	(Standby)	(Standby pin high)		50	120	μA
Standby low-level	VIL	Note 3				
input voltage	(Standby)				0.8	V
Standby high-level	Vін					
input voltage	(Standby)		2.0			V
Input capacitance		Driver input and receiver input				
	CIN	$V_{CC}$ = +5 V, vs. GND, f = 1 MHz			10	pF

\* TYP.: Typical (reference) value at  $T_A = 25$  °C.

**Note 3.** Because the standby pin is internally pulled down, if the standby pin is left open, operating mode is in effect.

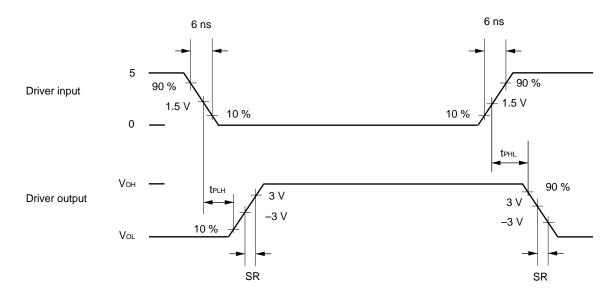
# ELECTRICAL CHARACTERISTICS (DRIVER) (Unless otherwise specified, Vcc = +5 V $\pm$ 10 %, T<sub>A</sub> = -20 °C to +80 °C, C<sub>1</sub> to C<sub>4</sub> = 22 $\mu$ F)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Low-level input voltage	VIL				0.8	V
High-level input voltage	Vін		2.0			V
Low-level input current	١ı		0		-1.0	μA
High-level input current	Ін		0		1.0	μA
Output voltage		$V_{CC} = +5.0 \text{ V}, \text{ R}_{L} = \infty, \text{ T}_{A} = 25 ^{\circ}\text{C}$		±9.7		V
	Vdo	$V_{CC}$ = +5.0 V, $R_L$ = 3 k $\Omega$	±5.5			V
		$V_{CC}$ = +4.5 V, $R_L$ = 3 k $\Omega$	±5.0			V
Output short current	lsc	Vcc = +5.0 V, vs. GND		±15	±40	mA
Slew rate		$C_L = 10 \text{ pF}, R_L = 3 \text{ to } 7 \text{ k}\Omega$	1.5	9	30	V/µs
	SR	$C_L = 2500 \text{ pF}, R_L = 3 \text{ to } 7 \text{ k}\Omega$	1.5	5	30	V/µs
Propagation delay time Note 4	tрнL					
	tрын	RL = 3.5 kΩ, CL = 2500 pF		0.8		μs
Output resistance		Vcc = Vdd = Vss = 0 V				
	Ro	$V_{OUT} = \pm 2 V$	300			Ω
Standby output transition time	tdaz	Note 5		4	10	μs
Standby output transition time	<b>t</b> dza	Note 5		25	50	ms

\* TYP.: Typical (reference) value at  $T_A = 25$  °C.

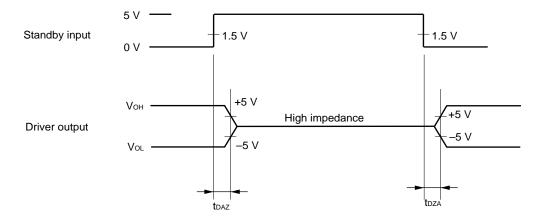
#### Note 4. Test point

If the output control pin is made low, the driver output goes low regardless of the driver input state.



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Note 5. Test Point



Do not perform communication within the standby output transition time t<sub>DZA</sub> on power application or on releasing the standby mode.

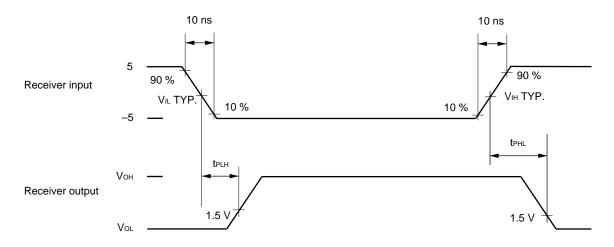
ELECTRICAL CHARACTERISTICS	G (RECEIVER)
(Unless otherwise specified, Vcc =	= +5 V ±10 %, T <sub>A</sub> = -20 °C to +80 °C, C <sub>1</sub> to C <sub>4</sub> = 22 $\mu$ F)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX	Unit
Low-level output voltage	Vol	Iout = 4 mA			0.4	V
High-level output voltage	Vон	lout = -4 mA	Vcc			V
	VOH	1001 = -4  mA	-0.8			v
Low-level input voltage	VIL	Rcon pin			0.8	V
High-level input voltage	Vін	Rcon pin	2.0			V
Propagation delay time Note 7	<b>t</b> PHL					
	<b>t</b> PLH	R∟ = 1 kΩ, C∟ = 150 pF		0.13		μs
Input current	IIN			1		mA
Input resistance	Rı		3	5	7	kΩ
Input pin release voltage	Vio	Input threshold A mode only			0.5	V
Input threshold A mode	Vін	Vcc = +5 V	1.6	2.2	2.6	V
(Rcon pin low)	VIL	Vcc = +5 V	0.6	1	1.6	V
	Vн	Vcc = +5 V (hysteresis width)	0.5	1.2	1.8	V
Input threshold B mode Note 6	Vih	Vcc = +5 V	1.6	2.2	2.6	V
(Rcoℕ pin high)	VIL	Vcc = +5 V	-0.4	-1.8	-3.0	V
Only applicable to the $\mu$ PD4712C	Vн	Vcc = +5 V (hysteresis width)	2.6	4.0	5.4	V
Input threshold C mode Note 6	Vін	Vcc = +5 V	-0.4	-0.8	-1.6	V
(Rcoℕ pin high)	VIL	Vcc = +5 V	-0.8	-2.0	-3.0	V
Only applicable to the $\mu$ PD4712D	Vн	Vcc = +5 V (hysteresis width)	0.5	1.2	1.8	V
Standby output transition time	<b>t</b> daz	Note 8		0.4	1	μs
Standby output transiton time	<b>t</b> dza	Note 8		0.03	10	ms

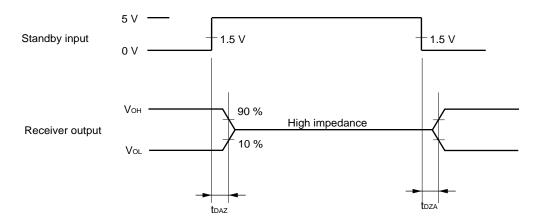
\* TYP.: Typical (reference) value at  $T_A = 25$  °C.

**Note 6.** This data is applicable to receivers 3 and 4 only. Receiver 1 and 2 are fixed in input threshold A mode.

#### Note 7. Test Point



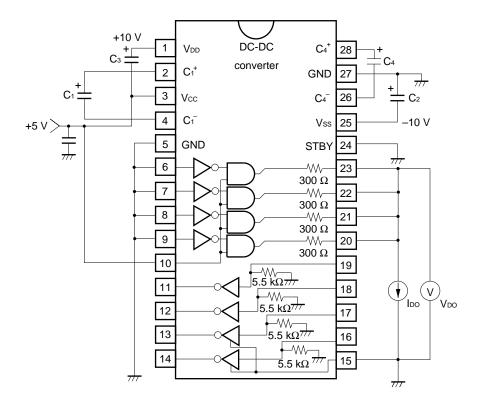
Note 8. Test Point



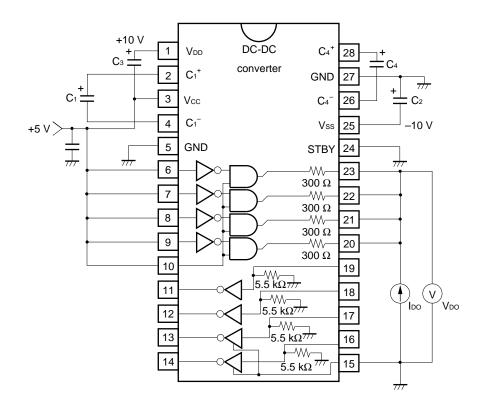
The receiver output is undefined during the standby output transition time t<sub>DZA</sub>. Do not perform communication in the standby output transition time t<sub>DZA</sub> on power application or on releasing the standby mode.

# TEST CIRCUIT

## Driver output voltage/Output current (+ side)

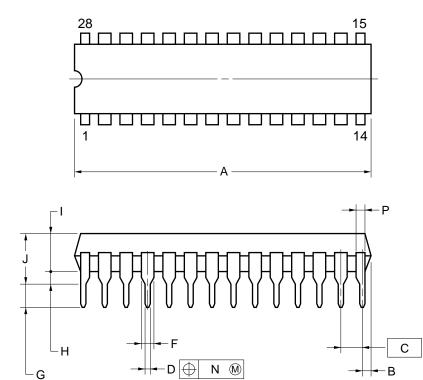


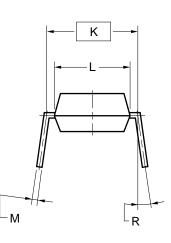
# Driver output voltage/Output current (- side)



# PACKAGE DRAWINGS

# 28PIN PLASTIC DIP (400 mil)



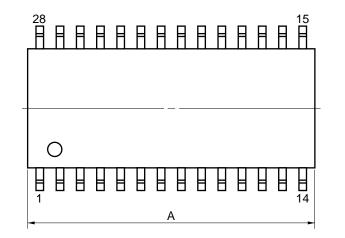


#### NOTES

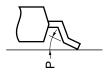
- 1) Each lead centerline is located within 0.25 mm (0.01 inch) of its true position (T.P.) at maximum material condition.
- 2) Item "K" to center of leads when formed parallel.

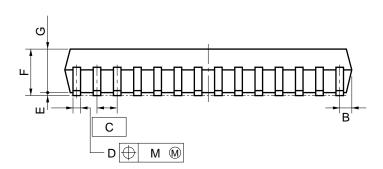
ITEM	MILLIMETERS	INCHES
А	35.56 MAX.	1.400 MAX.
В	1.27 MAX.	0.050 MAX.
С	2.54 (T.P.)	0.100 (T.P.)
D	0.50±0.10	$0.020^{+0.004}_{-0.005}$
F	1.1 MIN.	0.043 MIN.
G	3.5±0.3	0.138±0.012
н	0.51 MIN.	0.020 MIN.
I	4.31 MAX.	0.170 MAX.
J	5.72 MAX.	0.226 MAX.
К	10.16 (T.P.)	0.400 (T.P.)
L	8.6	0.339
М	$0.25^{+0.10}_{-0.05}$	$0.010^{+0.004}_{-0.003}$
Ν	0.25	0.01
Р	0.9 MIN.	0.035 MIN.
R	0~15°	0~15°
		P28C-100-400-1

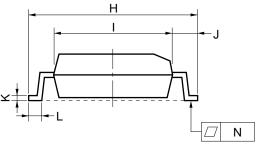
# 28 PIN PLASTIC SOP (375 mil)



detail of lead end







#### NOTE

Each lead centerline is located within 0.12 mm (0.005 inch) of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS	INCHES
А	18.07 MAX.	0.712 MAX.
В	0.78 MAX.	0.031 MAX.
С	1.27 (T.P.)	0.050 (T.P.)
D	$0.40^{+0.10}_{-0.05}$	$0.016^{+0.004}_{-0.003}$
E	0.1±0.1	0.004±0.004
F	2.9 MAX.	0.115 MAX.
G	2.50	0.098
Н	10.3±0.3	$0.406\substack{+0.012\\-0.013}$
I	7.2	0.283
J	1.6	0.063
к	$0.15^{+0.10}_{-0.05}$	$0.006^{+0.004}_{-0.002}$
L	0.8±0.2	$0.031^{+0.009}_{-0.008}$
М	0.12	0.005
Ν	0.15	0.006
Р	3°+7° -3°	3° <sup>+7°</sup> -3°
		P28GM-50-375B-3

## **RECOMMENDED SOLDERING CONDITIONS**

Soldering the  $\mu$ PD4712C and 4712D under the conditions listed in the table below is recommended. For soldering methods and conditions other than those recommended, consult NEC.

#### Surface mount type

For the details of the recommended soldering conditions of the surface mount type, refer to Information document "Semiconductor Device Mounting Technology Manual" (C10535EJ7V0IF00)

#### $\mu$ PD4712CGT, 4712DGT

Soldering Method	Soldering Condition	Recommended Condition Symbol
Infrared reflow	Package peak temperature: 235 °C, Time: 3 0 seconds MAX.	IR35-00-2
	(210 °C MIN.), Number of times: 2, Number of days: not	
	limited*	
VPS	Package peak temperature: 215 °C, Time: 40 seconds MAX.	VP15-00-2
	(200 °C MIN.), Number of times: 2, Number of days: not	
	limited*	
Wave soldering	Soldering bath temperature: 260 °C MAX., Time: 10 seconds	WS60-00-1
	MAX., Number of times: 1, Number of days: not limited*	
Pin partial heating	Pin temperature: 300 °C MAX. (lead temperature), Time: 3	
	seconds MAX. (per lead pin), Number of days: not limited*	

\* The number of days the device can be stored at 25 °C, 65 % RH MAX. after the dry pack has been opened.

Caution Do not use two or more soldering methods in combination (except the pin partial heating method).

#### Throught-hole type

#### $\mu$ PD4712CCY, 4712DCY

Soldering Method	Soldering Conditions	
Wave soldering	Soldering bath temperature: 260 °C MAX., Time: 10 seconds MAX.	

#### **REFERENCE DOCUMENTS**

"NEC Semiconductor Device Reliability/Quality Control System" (IEI-1212)

"Quality Grade on NEC Semiconductor Devices" (IEI-1209)

"Semiconductor Device Mounting Technology Manual" (C10535EJ7V0IF00)

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